

INTERNATIONAL  
GEMOLOGICAL  
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

January 7, 2026

IGI Report Number

DESCRIPTION

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

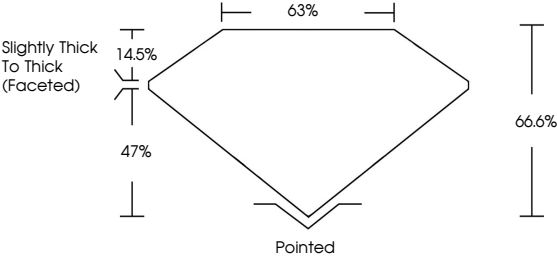
Inscription(s)

Comments: As Grown - No indication of post-growth treatment.  
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.  
Type II

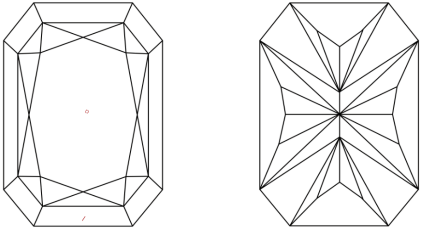
LG764625588

Report verification at igi.org

PROPORTIONS



CLARITY CHARACTERISTICS




KEY TO SYMBOLS

Red symbols indicate internal characteristics.  
Green symbols indicate external characteristics.

COLOR

CLARITY

Sample Image Used



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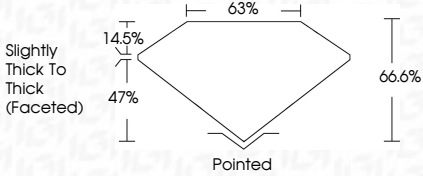
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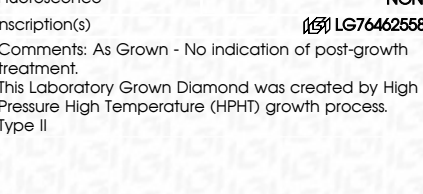
PROPORTIONS




COLOR

CLARITY

Sample Image Used



IGI



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CUT CORNERED RECT. MODIFIED BRILLIANT

8.08 X 5.54 X 3.69 MM

1.40 CARAT

D

VVS 2

66.6%

63%

Slightly Thick To Thick (Faceted)

Pointed

EXCELLENT

EXCELLENT

NONE

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